



## Material Content Data Sheet



<b>Sales Product Name</b>		IPL60R225CFD7		<b>Issued</b>		4. July 2019		
<b>MA#</b>		MA002790412						
<b>Package</b>		PG-VSON-4-1		<b>Weight*</b>		187.89 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.709	1.97	1.97	19742	19742
leadframe	inorganic material	phosphorus	7723-14-0	0.020	0.01		108	
	non noble metal	zinc	7440-66-6	0.081	0.04		431	
	non noble metal	iron	7439-89-6	1.619	0.86		8614	
wire	non noble metal	copper	7440-50-8	65.718	34.98	35.89	349772	358925
	non noble metal	copper	7440-50-8	1.157	0.62	0.62	6159	6159
	encapsulation	organic material	carbon black	1333-86-4	0.219	0.12		1167
plating	plastics	epoxy resin	-	11.294	6.01		60109	
	inorganic material	silicondioxide	60676-86-0	98.135	52.23	58.36	522306	583582
leadfinish	non noble metal	tin	7440-31-5	2.397	1.28	1.28	12760	12760
plating	noble metal	silver	7440-22-4	0.252	0.13	0.13	1341	1341
solder	non noble metal	tin	7440-31-5	0.066	0.04		350	
	noble metal	silver	7440-22-4	0.082	0.04		437	
	non noble metal	lead	7439-92-1	3.139	1.67	1.75	16704	17491
*deviation	< 10%				Sum in total:	100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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